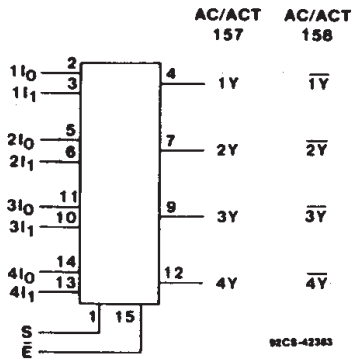




Data sheet acquired from Harris Semiconductor
SCHS283

CD54/74AC157, CD54/74AC158 CD54/74ACT157, CD54/74ACT158



FUNCTIONAL DIAGRAM

Quad 2-Input Multiplexers

AC/ACT157 - Non-Inverting

AC/ACT158 - Inverting

Type Features:

- Buffered inputs
- Typical propagation delay (AC/ACT158):
3.8 ns @ $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$, $C_L = 50\text{ pF}$

The RCA CD54/74AC157, -158 and CD54/74ACT157, -158 quad 2-input multiplexers use the RCA ADVANCED CMOS technology. Both circuits can select four bits of data from two sources under the control of a common select input (S). The Enable input (\bar{E}) is active LOW. When \bar{E} is HIGH, all of the outputs of the 158 are forced HIGH and in the 157, all of the outputs are forced LOW, regardless of all other input conditions.

The CD74AC/ACT157 and CD74AC/ACT158 are supplied in 16-lead dual-in-line plastic packages (E suffix) and in 16-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC157, -158 and CD54ACT157, -158, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

Family Features:

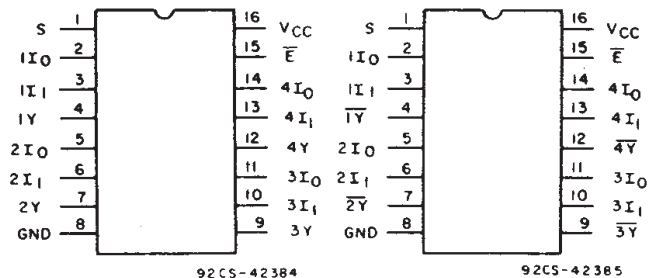
- Exceeds 2-kV ESD Protection - MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design
- Speed of bipolar FAST®/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply.
- ± 24-mA output drive current
 - Fanout to 15 FAST® ICs
 - Drives 50-ohm transmission lines

®FAST is a Registered Trademark of Fairchild Semiconductor Corp.

TRUTH TABLE

Enable	Select Input	Data Inputs		Output	
				157	158
\bar{E}	S	I_0	I_1	Y	\bar{Y}
H	X	X	X	L	H
L	L	L	X	L	H
L	L	H	X	H	L
L	H	X	L	L	H
L	H	X	H	H	L

H = High level, L = Low level, X = Don't care



CD54/74AC/ACT157

CD54/74AC/ACT158

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This data sheet is applicable to the CD54/74AC157 and CD74AC158. The CD54AC158, CD54ACT157, and CD54ACT158 were not acquired from Harris Semiconductor. See SCHS238 for information on the CD74ACT157 and CD74ACT158.

CD54/74AC157, CD54/74AC158 CD54/74ACT157, CD54/74ACT158

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE (V_{CC})	-0.5 to 6 V
DC INPUT DIODE CURRENT, I_{IK} (for $V_i < -0.5$ V or $V_i > V_{CC} + 0.5$ V)	± 20 mA
DC OUTPUT DIODE CURRENT, I_{OK} (for $V_o < -0.5$ V or $V_o > V_{CC} + 0.5$ V)	± 50 mA
DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, I_o (for $V_o > -0.5$ V or $V_o < V_{CC} + 0.5$ V)	± 50 mA
DC V_{CC} or GROUND CURRENT (I_{CC} or I_{GND})	± 100 mA*
POWER DISSIPATION PER PACKAGE (P_D):	
For $T_A = -55$ to $+100^\circ\text{C}$ (PACKAGE TYPE E)	500 mW
For $T_A = +100$ to $+125^\circ\text{C}$ (PACKAGE TYPE E)	Derate Linearly at 8 mW/ $^\circ\text{C}$ to 300 mW
For $T_A = -55$ to $+70^\circ\text{C}$ (PACKAGE TYPE M)	400 mW
For $T_A = +70$ to $+125^\circ\text{C}$ (PACKAGE TYPE M)	Derate Linearly at 6 mW/ $^\circ\text{C}$ to 70 mW
OPERATING-TEMPERATURE RANGE (T_A)	-55 to $+125^\circ\text{C}$
STORAGE TEMPERATURE (T_{stg})	-65 to $+150^\circ\text{C}$
LEAD TEMPERATURE (DURING SOLDERING):	
At distance $1/16 \pm 1/32$ in. (1.59 ± 0.79 mm) from case for 10 s maximum	$+265^\circ\text{C}$
Unit inserted into PC board min. thickness $1/16$ in. (1.59 mm) with solder contacting lead tips only	$+300^\circ\text{C}$

* For up to 4 outputs per device; add ± 25 mA for each additional output.

RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range, V_{CC} *: (For $T_A =$ Full Package-Temperature Range) AC Types ACT Types	1.5 4.5	5.5 5.5	V V
DC Input or Output Voltage, V_i, V_o	0	V_{CC}	V
Operating Temperature, T_A	-55	+125	$^\circ\text{C}$
Input Rise and Fall Slew Rate, dt/dv at 1.5 V to 3 V (AC Types) at 3.6 V to 5.5 V (AC Types) at 4.5 V to 5.5 V (ACT Types)	0 0 0	50 20 10	ns/V ns/V ns/V

*Unless otherwise specified, all voltages are referenced to ground.

CD54/74AC157, CD54/74AC158 CD54/74ACT157, CD54/74ACT158

STATIC ELECTRICAL CHARACTERISTICS: AC Series

CHARACTERISTICS	TEST CONDITIONS		V _{CC} (V)	AMBIENT TEMPERATURE (T _A) - °C						UNITS
				+25		-40 to +85		-55 to +125		
	V _I (V)	I _O (mA)		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
High-Level Input Voltage V _{IH}			1.5	1.2	—	1.2	—	1.2	—	V
			3	2.1	—	2.1	—	2.1	—	
			5.5	3.85	—	3.85	—	3.85	—	
Low-Level Input Voltage V _{IL}			1.5	—	0.3	—	0.3	—	0.3	V
			3	—	0.9	—	0.9	—	0.9	
			5.5	—	1.65	—	1.65	—	1.65	
High-Level Output Voltage V _{OH}	V _{IH} or V _{IL}	-0.05	1.5	1.4	—	1.4	—	1.4	—	V
			3	2.9	—	2.9	—	2.9	—	
			4.5	4.4	—	4.4	—	4.4	—	
			3	2.58	—	2.48	—	2.4	—	
			4.5	3.94	—	3.8	—	3.7	—	
			5.5	—	—	3.85	—	—	—	
Low Level Output Voltage V _{OL}	V _{IH} or V _{IL}	0.05	1.5	—	0.1	—	0.1	—	0.1	V
			3	—	0.1	—	0.1	—	0.1	
			4.5	—	0.1	—	0.1	—	0.1	
			3	—	0.36	—	0.44	—	0.5	
			4.5	—	0.36	—	0.44	—	0.5	
			5.5	—	—	—	1.65	—	—	
Input Leakage Current I _I	V _{CC} or GND		5.5	—	±0.1	—	±1	—	±1	μA
Quiescent Supply Current, MSI I _{CC}	V _{CC} or GND	0	5.5	—	8	—	80	—	160	μA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

CD54/74AC157, CD54/74AC158 CD54/74ACT157, CD54/74ACT158

STATIC ELECTRICAL CHARACTERISTICS: ACT Series

CHARACTERISTICS	TEST CONDITIONS	V_{CC} (V)	AMBIENT TEMPERATURE (T_A) - °C						UNITS		
			+25		-40 to +85		-55 to +125				
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.			
High-Level Input Voltage	V_{IH}		4.5 to 5.5	2	—	2	—	2	—	V	
Low-Level Input Voltage	V_{IL}		4.5 to 5.5	—	0.8	—	0.8	—	0.8	V	
High-Level Output Voltage	V_{OH}	V_{IH} or V_{IL} #, *	-0.05	4.5	4.4	—	4.4	—	4.4	—	V
			-24	4.5	3.94	—	3.8	—	3.7	—	
			-75	5.5	—	—	3.85	—	—	—	
			-50	5.5	—	—	—	—	3.85	—	
Low-Level Output Voltage	V_{OL}	V_{IH} or V_{IL} #, *	0.05	4.5	—	0.1	—	0.1	—	0.1	V
			24	4.5	—	0.36	—	0.44	—	0.5	
			75	5.5	—	—	—	1.65	—	—	
			50	5.5	—	—	—	—	—	1.65	
Input Leakage Current	I_i	V_{CC} or GND		5.5	—	±0.1	—	±1	—	±1	μA
Quiescent Supply Current, MSI	I_{CC}	V_{CC} or GND	0	5.5	—	8	—	80	—	160	μA
Additional Quiescent Supply Current per Input Pin TTL Inputs High 1 Unit Load	ΔI_{CC}	$V_{CC}-2.1$		4.5 to 5.5	—	2.4	—	2.8	—	3	mA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

* Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

ACT INPUT LOADING TABLE

INPUT	UNIT LOAD*	
	157	158
I (All)	0.37	0.37
\bar{E}	0.83	0.83
S	1.33	1.33

*Unit load is ΔI_{CC} limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

CD54/74AC157, CD54/74AC158 CD54/74ACT157, CD54/74ACT158

SWITCHING CHARACTERISTICS: AC Series; $t_r, t_f = 3 \text{ ns}$, $C_L = 50 \text{ pF}$

CHARACTERISTICS	SYMBOL	V_{CC} (V)	AMBIENT TEMPERATURE (T_A) - °C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Propagation Delays: Data to Output	(157) t_{PLH} t_{PHL}	1.5	—	97	—	106	ns
		3.3*	3.2	10.8	3	11.9	
Enable to Output	(157) t_{PLH} t_{PHL}	5†	2.2	7.7	2.1	8.5	ns
		1.5	—	154	—	169	
Select to Output	(157) t_{PLH} t_{PHL}	3.3	5.1	17.2	4.7	18.9	ns
		5	3.6	12.3	3.4	13.5	
Data to Output	(158) t_{PLH} t_{PHL}	1.5	—	164	—	180	ns
		3.3	5.4	18.5	5.1	20.3	
Enable to Output	(158) t_{PLH} t_{PHL}	5	3.8	13.2	3.6	14.5	ns
		1.5	—	91	—	100	
Select to Output	(158) t_{PLH} t_{PHL}	3.3	3	12.8	2.8	11.2	ns
		5	2.2	7.3	2	8	
Power Dissipation Capacitance	(157) (158) $C_{PD§}$	1.5	—	135	—	149	pF
		3.3	4.5	15.2	4.2	16.7	
Input Capacitance	C_I	5	3.2	10.8	3	11.9	pF
		1.5	—	147	—	161	
Select to Output	(158) t_{PLH} t_{PHL}	3.3	4.9	16.5	4.5	18.1	ns
		5	3.5	11.7	3.2	12.9	
Power Dissipation Capacitance	$C_{PD§}$	—	156 Typ. 149 Typ.		156 Typ. 149 Typ.		pF
Input Capacitance	C_I	—	—	10	—	10	pF

SWITCHING CHARACTERISTICS: ACT Series; $t_r, t_f = 3 \text{ ns}$, $C_L = 50 \text{ pF}$

CHARACTERISTICS	SYMBOL	V_{CC} (V)	AMBIENT TEMPERATURE (T_A) - °C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Propagation Delays: Data to Output	(157) t_{PLH} t_{PHL}	5†	2.5	8.6	2.4	9.5	ns
		1.5	—	154	—	169	
Enable to Output	(157) t_{PLH} t_{PHL}	5	3.6	12.3	3.4	13.5	ns
		1.5	—	164	—	180	
Select to Output	(157) t_{PLH} t_{PHL}	5	3.8	13.2	3.6	14.5	ns
		1.5	—	91	—	100	
Data to Output	(158) t_{PLH} t_{PHL}	5	2.4	8.4	2.3	9.2	ns
		1.5	—	135	—	149	
Enable to Output	(158) t_{PLH} t_{PHL}	5	3.3	11.3	3.1	12.4	ns
		1.5	—	147	—	161	
Select to Output	(158) t_{PLH} t_{PHL}	5	3.6	12.3	3.4	13.5	ns
		1.5	—	135	—	149	
Power Dissipation Capacitance	$C_{PD§}$	—	156 Typ. 149 Typ.		156 Typ. 149 Typ.		pF
Input Capacitance	C_I	—	—	10	—	10	pF

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*3.3 V: min. is @ 3.6 V
max. is @ 3 V

†5 V: min. is @ 5.5 V
max. is @ 4.5 V

§ C_{PD} is used to determine the dynamic power consumption, per function.

For AC Series, $P_D = C_{PD} V_{CC}^2 f_i + \Sigma(C_L V_{CC}^2 f_o)$

For ACT Series, $P_D = C_{PD} V_{CC}^2 f_i + \Sigma(C_L V_{CC}^2 f_o) + V_{CC} \Delta I_{CC}$

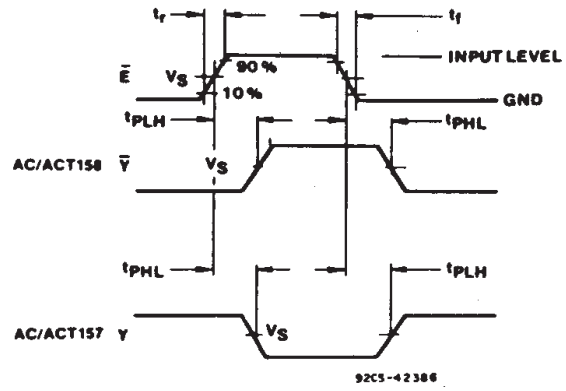
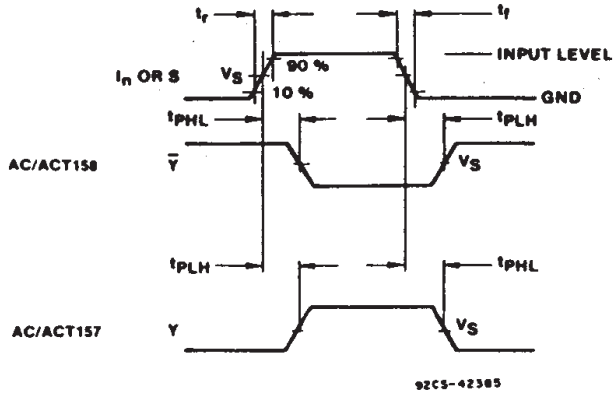
where f_i = input frequency

f_o = output frequency

C_L = output load capacitance

V_{CC} = supply voltage.

CD54/74AC157, CD54/74AC158 CD54/74ACT157, CD54/74ACT158



	CD54/74AC	CD54/74ACT
Input Level	V_{CC}	3 V
Input Switching Voltage, V_S	$0.5 V_{CC}$	1.5 V
Output Switching Voltage, V_S	$0.5 V_{CC}$	$0.5 V_{CC}$

Fig. 3 - Inputs or select to output propagation delays.

Fig. 4 - \bar{E} enable to output propagation delays.

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